FALL 2016 ENGINEERING PATHWAYS TO UIUC

Engineering Pathways offers guaranteed admission to the College of Engineering at the University of Illinois at Urbana-Champaign (UIUC) for qualifying students who complete their first two years of coursework at Oakton Community College.

REQUIREMENTS

- Applicants must be high school seniors who are first-time college students.
- Accepted students must enroll full time at Oakton (at least 12 credit hours) and complete all required courses.
- Accepted students must maintain a 3.3 GPA in required courses and a 3.2 cumulative GPA at Oakton.

APPLICATION PROCESS

Submit the following documents by March 15, 2016 to:

Oakton Community College
Enrollment Center (Room 1860), 1600 East Golf Road, Des Plaines, IL 60016
or (Room A100), 7701 North Lincoln Avenue, Skokie, IL 60077, Attn: Nicci Cisarik.
- Oakton’s general application found at www.oakton.edu/admission.
- UIUC’s Engineering Pathways application found at bit.ly/1p1jhRr.
- A typed personal statement of no more than 500 words addressing why you want to pursue a degree/career in engineering, and why you would like to participate in the Engineering Pathways program.
- Official seventh semester high school transcript and ACT scores.

For more information contact:

Oakton Community College
Student Recruitment and Outreach, 1600 East Golf Road, Des Plaines, IL 60016
Nicci Cisarik, ncsarik@oakton.edu, 847.635.1835
or
University of Illinois at Urbana-Champaign
College of Engineering, Engineering Pathways, 206 Engineering Hall, 1308 West Green Street, Urbana, IL 61801
217.333.2280, engineeringpathways@illinois.edu
Application for Program Participation

Complete all portions of this application and return it by mail or in person with a copy of your seventh semester high school transcript, ACT score and personal statement to: Enrollment Center, Oakton Community College, 1600 East Golf Road, Des Plaines, Illinois, 60016, Attn: Nicci Cisarik. Application deadline: Tuesday, March 15, 2016.

Please print all entries except for signatures

Name of student (Last, First, M.I.) ___________________________________________________________________________ Birth date __________/_______/_______ Gender ___________________________________________________________________________

Address (include apt./unit no.) ____________________________________________________________________________________ City __________________________________________________________________________

Phone (home and cell) ___________________________________________________________________________________________ E-mail __________________________________________________________________________

High school ____________________________________________________________________________________________ High school graduation date __________/_______/_______ High school GPA __________ ACT score __________

What is your intended engineering major?

☐ Aerospace ☐ Computer ☐ Engineering Mechanics ☐ Materials Science
☐ Agricultural and Biological ☐ Civil and Environmental ☐ Industrial ☐ Nuclear Plasma and Radiological
☐ Computer Science ☐ Electrical ☐ Mechanical ☐ Undecided

Personal statement: Please compose a personal statement, no more than one page, addressing why you want to pursue a degree/career in engineering and why you would like to be a participant in this program.

This information is requested solely to comply with Federal reporting requirements.

1. Are you Hispanic or Latino? (OR Are you of Spanish origin?) ☐ Yes Hispanic or Latino. ☐ Not Hispanic or Latino.

2. Are you from one or more of the following racial groups? (Select all that apply).

☐ American Indian or Alaska Native ☐ Asian ☐ Black or African American ☐ Native Hawaiian or Other Pacific Islander ☐ White ☐ Choose Not to Respond

3. Please identify your primary racial/ethnic group. (Select one).

☐ American Indian or Alaska Native ☐ Asian ☐ Black or African American ☐ Hispanic or Latino
☐ Native Hawaiian or Other Pacific Islander ☐ White ☐ Choose Not to Respond


Provide Home Country of Origin ____________________________________________

I certify the above statements are complete and correct. I understand that if I withhold or give false information on this application it may make me ineligible for admission to the college or subject me to dismissal.

Student signature __________________________________________________________________________ Date __________

Questions about applying? Contact Student Recruitment and Outreach, 847.635.1835, or visit www.pathways.engineering.illinois.edu.

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